

### 3.2x1.6mm SMD CHIP LED LAMP

PRELIMINARY SPEC



**ATTENTION** OBSERVE PRECAUTIONS FOR HANDLING **ELECTROSTATIC** DISCHARGE SENSITIVE **DEVICES** 

Part Number: KPTD-3216ZGC

### **Features**

- 3.2mmX1.6mm SMT LED, 1.8mm THICKNESS.
- LOW POWER CONSUMPTION.
- WIDE VIEWING ANGLE.
- IDEAL FOR BACKLIGHT AND INDICATOR.
- VARIOUS COLORS AND LENS TYPES AVAILABLE.
- PACKAGE: 2000PCS / REEL .
- MOISTURE SENSITIVITY LEVEL: LEVEL 3.
- RoHS COMPLIANT.

## Description

The Green source color devices are made with AllnGaN on Sapphire Light Emitting Diode.

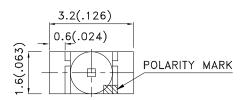
Green

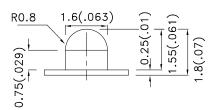
Static electricity and surge damage the LEDS.

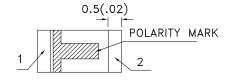
It is recommended to use a wrist band or anti-electrostatic glove when handling the LEDs.

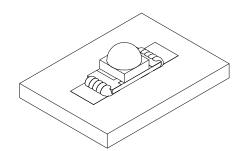
All devices, equipment and machinery must be electrically grounded.

# **Package Dimensions**









- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is  $\pm 0.2 (0.008")$  unless otherwise noted.
- 3. Specifications are subject to change without notice.4. The device has a single mounting surface. The device must be mounted according to the specifications.





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## **Selection Guide**

Part No.	Dice	Lens Type	lv (mcd) [2] @ 20mA		Viewing Angle [1]
		,,	Min.	Тур.	201/2
KPTD-3216ZGC	Green (AllnGaN)	WATER CLEAR	380	850	50°

- θ1/2 is the angle from optical centerline where the luminous intensity is 1/2 the optical centerline value.
   Luminous intensity/ luminous Flux: +/-15%.

# Electrical / Optical Characteristics at TA=25°C

Symbol	Parameter	Device	Тур.	Max.	Units	Test Conditions
λpeak	Peak Wavelength	Green	515		nm	IF=20mA
λD [1]	Dominant Wavelength	Green	525		nm	IF=20mA
Δλ1/2	Spectral Line Half-width	Green	30		nm	IF=20mA
С	Capacitance	Green	45		pF	VF=0V;f=1MHz
VF [2]	Forward Voltage	Green	3.3	4.1	V	IF=20mA
lR	Reverse Current	Green		10	uA	V <sub>R</sub> =5V

- 1.Wavelength: +/-1nm.
- 2. Forward Voltage: +/-0.1V.

## Absolute Maximum Ratings at TA=25°C

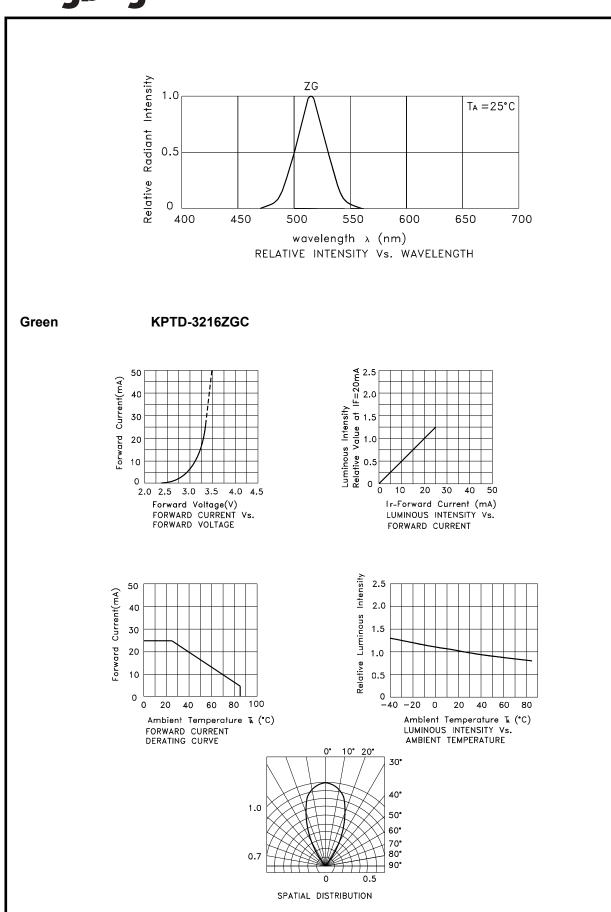
Parameter	Green	Units	
Power dissipation	102.5	mW	
DC Forward Current	25	mA	
Peak Forward Current [1]	150	mA	
Reverse Voltage	5	V	
Operating Temperature	-40°C To +85°C		
Storage Temperature	-40°C To +85°C		

## Note:

1. 1/10 Duty Cycle, 0.1ms Pulse Width.

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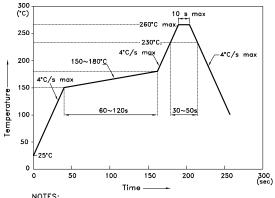
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## KPTD-3216ZGC

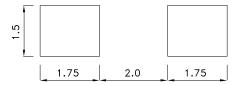
Reflow Soldering Profile For Lead-free SMT Process.



- NOTES:

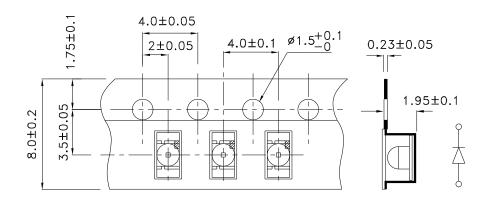
  1.We recommend the reflow temperature 245°C(+/-5°C).The maximum soldering temperature should be limited to 260°C. 2.Don't cause stress to the epoxy resin while it is exposed to high temperature.
   3.Number of reflow process shall be 2 times or less.

**Recommended Soldering Pattern** (Units: mm; Tolerance: ± 0.1)



**Tape Specifications** (Units: mm)

TAPE



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